

SLOVENSKI STANDARD oSIST prEN 62769-6:2018

01-julij-2018

Naprave in integracija v proizvodnih sistemih; integracija procesne naprave - 6. del: Načrtovanje tehnologije (FDI)

Field Device Integration (FDI) - Part 6: FDI Technology Mapping

Feldgeräteintegration (FDI) - Teil 6: FDI-Technologieabbildungen

Intégration des dispositifs de terrain (FDI) - Partie 6: Mapping de technologies FDI (standards.iteh.ai)

Ta slovenski standard je istoveten z: prEN 62769-6:2018

https://standards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8-

c9698c16cb2b/ksist-fpren-62769-6-2021

ICS:

25.040.40	Merjenje in krmiljenje industrijskih postopkov	Industrial process measurement and control
35.240.50	Uporabniške rešitve IT v industriji	IT applications in industry

oSIST prEN 62769-6:2018 en,fr,de

oSIST prEN 62769-6:2018

iTeh STANDARD PREVIEW (standards.iteh.ai)

<u>kSIST FprEN 62769-6:2021</u> https://standards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8-c9698c16cb2b/ksist-fpren-62769-6-2021 oSIST prEN 62769-6:2018

PROJECT NUMBER:



65E/593/CDV

COMMITTEE DRAFT FOR VOTE (CDV)

	IEC 62769-6 ED2	2	
	DATE OF CIRCULATION	ON:	CLOSING DATE FOR VOTING:
	2018-05-18		2018-08-10
	SUPERSEDES DOCUI	MENTS:	
	65E/537/RR		
IEC SC 65E : DEVICES AND INTEGRATIO	N IN ENTERPRISE SYS	TEMS	
SECRETARIAT:		SECRETARY:	
United States of America		Mr Donald (Bob)	Lattimer
OF INTEREST TO THE FOLLOWING COMMI	TTEES:	PROPOSED HORIZONTAL STANDARD:	
iTeh S	STANDA	any, in this CDV to	requested to indicate their interest, if the secretary.
FUNCTIONS CONCERNED:	(standard	ls.iteh.ai)	
☐ EMC ☐ ENVIR	ONMENT kSIST FprEN	QUALITY ASSURA	ANCE SAFETY
SUBMITTED FOR CENETEC PARADLE	-		FOR CENELEC PARALLEL VOTING
	c9698c16cb2b/ksist-	pren-62769-6-2021	
The attention of IEC National Commi	•		
CENELEC, is drawn to the fact that the for Vote (CDV) is submitted for parallel	is Committee Draft		
The CENELEC members are invited to CENELEC online voting system.	o vote through the		
This document is still under study and	subject to change.	t should not be use	d for reference purposes.
Recipients of this document are invite which they are aware and to provide s			cation of any relevant patent rights of
TITLE:			
Field Device Integration (FDI) - F	Part 6: FDI Techn	ology Mapping	
PROPOSED STABILITY DATE: 2021			
NOTE FROM TC/SC OFFICERS:			

Copyright © 2018 International Electrotechnical Commission, IEC. All rights reserved. It is permitted to download this electronic file, to make a copy and to print out the content for the sole purpose of preparing National Committee positions. You may not copy or "mirror" the file or printed version of the document, or any part of it, for any other purpose without permission in writing from IEC.

oSIST prEN 62769-6:2018

iTeh STANDARD PREVIEW (standards.iteh.ai)

<u>kSIST FprEN 62769-6:2021</u> https://standards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8-c9698c16cb2b/ksist-fpren-62769-6-2021

CONTENTS

FC	REWO	PRD	2
IN	TRODU	JCTION	4
1	Scop	oe	5
2	Norm	native references	5
3	Term	ns, definitions, abbreviated terms, acronyms and conventions	5
	3.1	Terms and definitions	
	3.2	Abbreviated terms and acronyms	
	3.3	Symbols	
4		nical concepts	
	4.1	General	6
	4.1.1		
	4.1.2	Platforms	6
	4.1.3		
	4.2	UIP representation	8
	4.3	UIP executable representation	8
	4.4	UIP executable compatibility rules	9
	4.5	Allowed .NET Common Language Run-time versions	9
	4.5.1	General	9
	4.5.2	CLR compatibility stategolards.iteh.ai)	9
	4.5.3	How to identify the .NET target platform of a UIP	. 10
	4.6	UIP Deployment <u>kSIST FprEN 62769-6:2021</u>	. 10
	4.7	UIP Life-cyclestandards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8-	. 10
	4.7.1	General c9698c16cb2b/ksist-fpren-62769-6-2021	. 10
	4.7.2	UIP Assembly activation steps	.11
	4.7.3	UIP Assembly deactivation steps	.13
	4.8	Interaction between an FDI Client and a UIP	.13
	4.8.1	Handling of standard UI elements	.13
	4.8.2	Non-blocking service execution	. 14
	4.8.3	Blocking service execution	. 15
	4.8.4	Cancel service execution	. 15
	4.8.5	Threading	. 16
	4.8.6	Timeout	. 16
	4.8.7	Exception handling	. 17
	4.8.8	Type safe interfaces	. 17
	4.8.9	Globalization and localization	. 18
	4.8.1	0 WPF Control handling	. 18
	4.8.1	1 Win Form handling	. 18
	4.9	Security	. 18
	4.9.1	General	. 18
	4.9.2	Access permissions	. 18
	4.9.3	, ,	
5	Interf	face definition	. 19
Fi	gure 1 –	- FDI Type Library structure	8
Fig	gure 2 –	NET surrogate process	. 10

IEC CDV 62769-6 © IEC:2018

- 3 -

Figure 3 – Identification of Run-time Version	10
Figure 4 – IAsyncPattern based asynchronous service execution example	14
Figure 5 – Blocking service execution example using IAsyncResult based pattern	15
Figure 6 – Cancel service processing sequence example	15
Figure 7 – Exception source	17
Table 1 – Technology edition reference	7
Table 2 – Base Property Services	20
Table 3 – Device Model Services	20
Table 4 – Access Control Services	20
Table 5 – Direct Access Services	20
Table 6 – Hosting Services	21
Table 7 – UIP Services	22
Table 8 – Base Data Types	22
Table 9 – Special Types	22

iTeh STANDARD PREVIEW (standards.iteh.ai)

kSIST FprEN 62769-6:2021 https://standards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8-c9698c16cb2b/ksist-fpren-62769-6-2021

IEC CDV 62769-6 © IEC:2018

– 2 –

INTERNATIONAL ELECTROTECHNICAL COMMISSION

2	
2	

FIELD DEVICE INTEGRATION (FDI) -

Part 6: Technology Mapping

FOREWORD

1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.

- The formal decisions or agreements of IEC on technical matters express, as nearly as possible, an international consensus of opinion on the relevant subjects since each technical committee has representation from all interested IEC National Committees.
- 3) IEC Publications have the form of recommendations for international use and are accepted by IEC National Committees in that sense. While all reasonable efforts are made to ensure that the technical content of IEC Publications is accurate, IEC cannot be held responsible for the way in which they are used or for any misinterpretation by any end user.
- 4) In order to promote international uniformity, IEC National Committees undertake to apply IEC Publications transparently to the maximum extent possible in their national and regional publications. Any divergence between any IEC Publication and the corresponding national or regional publication shall be clearly indicated in the latter.

 2698c16cb2b/ksist-fpren-62769-6-2021
- 5) IEC itself does not provide any attestation of conformity. Independent certification bodies provide conformity assessment services and, in some areas, access to IEC marks of conformity. IEC is not responsible for any services carried out by independent certification bodies.
 - 6) All users should ensure that they have the latest edition of this publication.
 - 7) No liability shall attach to IEC or its directors, employees, servants or agents including individual experts and members of its technical committees and IEC National Committees for any personal injury, property damage or other damage of any nature whatsoever, whether direct or indirect, or for costs (including legal fees) and expenses arising out of the publication, use of, or reliance upon, this IEC Publication or any other IEC Publications.
 - 8) Attention is drawn to the Normative references cited in this publication. Use of the referenced publications is indispensable for the correct application of this publication.
- 43 9) Attention is drawn to the possibility that some of the elements of this IEC Publication may be the subject of patent rights. IEC shall not be held responsible for identifying any or all such patent rights.
- International Standard IEC 62769 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.
- This second edition cancels and replaces the first edition published in: 2015. This edition constitutes a technical revision.
- This edition includes the following significant technical changes with respect to the previous edition:
 - a) Support for generic protocol extension for faster adoption of other technologies
 - b) Support for Package Developers to build EDDs targeted for today's EDD bases system under a single development tool.
 - c) Digital signature now include trusted timestamping for long term validation of FDI Package

IEC CDV 62769-6 © IEC:2018

-3-

57 58

59

61

- d) Running UIPs in a sandbox
- e) Time stamp for device package signature
- 60 f) Support of new protocols
 - g) Generic protocol extension to allow adoption of other communication protocols
 - h) Based on generic protocol extension: Modbus RTU;

62 63

64

The text of this International Standard is based on the following documents:

FDIS	Report on voting
65E/XXX/FDIS	65E/XXX/RVD

65

- Full information on the voting for the approval of this International Standard can be found in 66 the report on voting indicated in the above table. 67
- This document has been drafted in accordance with the ISO/IEC Directives, Part 2. 68
- The committee has decided that the contents of this document will remain unchanged until the 69 stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to 70
- the specific document. At this date, the document will be R R V IR W 71
- reconfirmed, 72
- (standards.iteh.ai)
- 73 withdrawn,
- replaced by a revised edition, or KSIST FprEN 62769-6:2021 74
 - https://standards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8c9698c16cb2b/ksist-fpren-62769-6-2021
 - amended.

75 76

77

78

79

80

- The National Committees are requested to note that for this document the stability date is 2022.
- THIS TEXT IS INCLUDED FOR THE INFORMATION OF THE NATIONAL COMMITTEES AND WILL BE DELETED AT THE PUBLICATION STAGE.

IMPORTANT - The 'colour inside' logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this document using a colour printer.

81 82 – 4 –

IEC CDV 62769-6 © IEC:2018

INTRODUCTION 83 The IEC 62769 series has the general title "Field Device Integration (FDI)" and the following 84 85 Part 1: Overview 86 Part 2: FDI Client 87 Part 3: FDI Server 88 Part 4: FDI Packages 89 90 Part 5: FDI Information Model Part 6: FDI Technology Mapping 91 Part 7: FDI Communication Devices 92 Part 100: Profiles - Generic Protocol Extensions 93 Part 101-1: Profiles - Foundation Fieldbus H1 94 Part 101-2: Profiles - Foundation Fieldbus HSE 95 Part 103-1: Profiles - PROFIBUS 96 Part 103-4: Profiles - PROFINET 97 Part 109-1: Profiles - HART and WirelessHART 98 Part 115-2: Profiles – Protocol-specific Definitions for Modbus RTU 99 Part 150-1: Profiles TISA 100 11a NDARD PREVIEW 100

> <u>kSIST FprEN 62769-6:2021</u> https://standards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8-

(standards.iteh.ai)

c9698c16cb2b/ksist-fpren-62769-6-2021

101

IEC CDV 62769-6 © IEC:2018 - 5 -

102	FIELD DEVICE INTEGRATION (FDI) -
103 104	Part 6: Technology Mapping
105	
106	
107	1 Scope
108 109 110 111	This part of IEC 62769 specifies the technology mapping for the concepts described in the Field Device Integration (FDI) standard. The technology mapping focuses on implementation regarding the components FDI Client and User Interface Plug-in (UIP) that are specific only to the WORKSTATION platform / .NET as defined in IEC 62769-4.
112	2 Normative references
113 114 115 116	The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.
117 118	IEC 61804 (all parts), Function blocks (FB) for process control and Electronic Device Description Language (EDDL)
119	IEC 62769-1, Field Device Integration (FDI) – Part 1: Overview
120	IEC 62769-2, Field Device Integration (FDI) - Part 2: FDI Client
121	IEC 62769-4, Field Device Integration (FDI) L Part 4. FDI Packages
122	IEC 62769-5, Field Device Integration (FDI) Part 5: FDI Information Model
123	IEC 62541 (all parts), OPC Unified Architecture (162724-ab6c-452f-a7c8-c9698c16cb2b/ksist-fpren-62769-6-2021
124 125	ISO/IEC 19505-1, Information technology – Object Management Group Unified Modeling Language (OMG UML) – Part 1: Infrastructure
126 127	ISO/IEC 29500, (all parts) Information technology - Document description and processing languages - Office Open XML File Formats
128	3 Terms, definitions, abbreviated terms, acronyms and conventions
129	3.1 Terms and definitions
130 131	For the purposes of this document, the terms and definitions given in IEC 62769-1 as well as the following apply.
132 133	ISO and IEC maintain terminological databases for use in standardization at the following addresses:
134	IEC Electropedia: available at http://www.electropedia.org/
135	 ISO Online browsing platform: available at http://www.iso.org/obp
136 137 138	3.1.1 application domain isolated environment where applications execute
139 140 141 142	3.1.2 assembly reusable, version information providing, and self-describing building block of a CLR application

- 6 **-**

IEC CDV 62769-6 © IEC:2018

3.1.3 143

FDI type library 144

- assembly that contains the interfaces and data types that are used for the data exchange and 145
- interaction between a UIP and an FDI Client 146
- 3.1.4 147
- global assembly cache 148
- machine-wide code cache that stores Assemblies specifically designated to be shared by 149
- several applications 150
- 3.1.5 151

155

158

161

- windows registry 152
- system-defined database in which applications and system components store and retrieve 153
- configuration data 154

Abbreviated terms and acronyms

For the purposes of this document, the abbreviated terms and acronyms given in IEC 62769-1 156

as well as the following apply. 157

> CLR Common Language Run-time

MSI Microsoft Installer

WPF Windows Presentation Foundation

UML Unified Modeling Language

iTeh STANDARD PREVIEW

Symbols 159

Figures in this document use the graphical symbols according to ISO/IEC 19505 (UML 2.0). 160

Technical concepts

kSIST FprEN 62769-6:2021 https://standards.iteh.ai/catalog/standards/sist/4c162724-ab6c-452f-a7c8-

c9698c16cb2b/ksist-fpren-62769-6-2021 162 4.1 General

4.1.1 Overview 163

- In 4.1.2, 4.2, 4.3, 4.4, and 4.5, this document describes first the technology base for UIP 164
- implementation, the hardware and software environment including the related implementation 165
- rules. Clause 4 follows a life-cycle (use case) oriented approach. 166
- Subclause 4.6 describes the copy deployment procedures and related implementation rules 167
- for the UIP and the FDI Client. UIP executable instantiation and termination is described in 168
- 4.7. Subclause 4.8 defines the rules about interaction between the FDI Client and the UIP. 169
- Security related definitions are written in 4.9. The service interface definitions for the FDI 170
- Client and the UIP are found in Clause 5. 171

4.1.2 **Platforms** 172

- The UIP and FDI Client shall be built upon the Microsoft .NET Framework and executed in 173
- the .NET Common Language Run-time. 174
- The minimum set of workstation supported I/O devices is: mouse, keyboard, and color screen 175
- resolution of 1024 x 768 pixels. 176
- The following Table 1 lists all the technologies and their editions that are consistent with FDI 177
- components. 178